



# Low Loss IGBT: IGBT in TRENCHSTOP™ technology

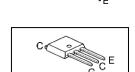








- Very low V<sub>CE(sat)</sub> 1.5 V (typ.)
- Maximum Junction Temperature 175°C
- Short circuit withstand time 5μs
- Designed for :
  - frequency inverters
  - drives
- TRENCHSTOP™ technology for 600V applications offers :
  - very tight parameter distribution
  - high ruggedness, temperature stable behavior
  - very high switching speed
  - Iow V<sub>CE(sat)</sub>
  - Positive temperature coefficient in V<sub>CE(sat)</sub>
- Low EMI
- Low Gate Charge
  - Qualified according to JEDEC<sup>1</sup> for target applications
- Complete product spectrum and PSpice Models: <a href="http://www.infineon.com/igbt/">http://www.infineon.com/igbt/</a>



PG-TO251-3

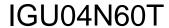
Туре	<b>V</b> <sub>CE</sub>	<i>I</i> <sub>C</sub>	V <sub>CE(sat), Tj=25°C</sub>	$T_{\rm j,max}$	Marking	Package
IGU04N60T	600 V	4 A	1.5 V	175 °C	G04T60	PG-TO251-3

#### **Maximum Ratings**

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V <sub>CE</sub>	600	V
DC collector current, limited by $T_{\text{jmax}}$ $T_{\text{C}} = 25^{\circ}\text{C}$ $T_{\text{C}} = 100^{\circ}\text{C}$	I <sub>C</sub>	9.5 6.5	А
Pulsed collector current, $t_p$ limited by $T_{jmax}$	I <sub>Cpuls</sub>	12	
Turn off safe operating area ( $V_{CE} \le 600V$ , $T_j \le 175$ °C)	-	12	
Gate-emitter voltage	V <sub>GE</sub>	±20	V
Short circuit withstand time <sup>2)</sup> $V_{GE} = 15V, \ V_{CC} \le 400V, \ T_j \le 150^{\circ}C$	tsc	5	μs
Power dissipation $T_C = 25^{\circ}C$	P <sub>tot</sub>	42	W
Operating junction temperature	T <sub>j</sub>	-40+175	°C
Storage temperature	$T_{\rm stg}$	-55+150	
Soldering temperature, wave soldering, 1.6mm (0.063 in.) from case for 10s.	Ts	260	°C

<sup>&</sup>lt;sup>1</sup> J-STD-020 and JESD-022

<sup>&</sup>lt;sup>2)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.





#### **Thermal Resistance**

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic	·			
IGBT thermal resistance,	$R_{thJC}$		3.5	K/W
junction – case				
Thermal resistance,	$R_{thJA}$		75	
junction – ambient				

# **Electrical Characteristic,** at $T_i = 25$ °C, unless otherwise specified

Danamatan	Symbol	Conditions	Value			11
Parameter	Symbol	Conditions	min.	Тур.	max.	Unit
Static Characteristic						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{\rm GE} = 0  \text{V}, I_{\rm C} = 0.2  \text{mA}$	600	1	-	V
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_{\rm GE} = 15  \rm V, \ I_{\rm C} = 4  \rm A$				
		<i>T</i> <sub>j</sub> =25°C	-	1.5	2.05	
		<i>T</i> <sub>j</sub> =175°C	-	1.9	-	
Gate-emitter threshold voltage	$V_{\text{GE(th)}}$	$I_{C}=60\mu\text{A}, V_{CE}=V_{GE}$	4.1	4.9	5.7	
Zero gate voltage collector current	I <sub>CES</sub>	V <sub>CE</sub> =600V, V <sub>GE</sub> =0V				μΑ
		<i>T</i> <sub>j</sub> =25°C	-	-	40	
		<i>T</i> <sub>j</sub> =175°C	-	40	-	
Gate-emitter leakage current	I <sub>GES</sub>	$V_{\text{CE}}=0\text{V}, V_{\text{GE}}=20\text{V}$	-	-	100	nA
Transconductance	$g_{fs}$	$V_{CE}=20V$ , $I_{C}=4A$	-	2.2	-	S

# **Dynamic Characteristic**

Input capacitance	Ciss	$V_{CE}=25V$ ,	-	252	-	pF
Output capacitance	Coss	$V_{GE}=0V$ ,	-	20	-	
Reverse transfer capacitance	Crss	f=1MHz	-	7.5	-	
Gate charge	Q <sub>Gate</sub>	$V_{\rm CC} = 480  \text{V}, I_{\rm C} = 4  \text{A}$	-	27	-	nC
		V <sub>GE</sub> =15V				
Internal emitter inductance	LE		-	7	-	nΗ
measured 5mm (0.197 in.) from case						
Short circuit collector current <sup>1)</sup>	$I_{C(SC)}$	$V_{\text{GE}} = 15 \text{V}, t_{\text{SC}} \le 5 \mu \text{S}$ $V_{\text{CC}} = 400 \text{V},$ $T_{\text{j}} \le 150^{\circ} \text{C}$	-	36	-	A

<sup>&</sup>lt;sup>1)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.



# IGU04N60T

# TRENCHSTOP™ Series

# Switching Characteristic, Inductive Load, at $T_j$ =25 °C

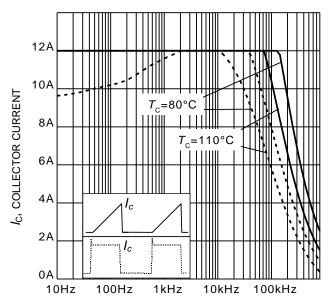
Parameter	Symbol	Conditions	Value			Unit
raiailletei	Symbol		min.	Тур.	max.	Ollic
IGBT Characteristic						
Turn-on delay time	$t_{d(on)}$	$T_{\rm j}$ =25°C,	-	14	-	ns
Rise time	$t_{\rm r}$	$V_{CC} = 400 \text{V}, I_{C} = 4 \text{A},$ $V_{GE} = 0/15 \text{V},$	-	7	-	
Turn-off delay time	$t_{d(off)}$	$r_{\rm G}$ =47 $\Omega$ , $L_{\sigma}$ =150nH, $C_{\sigma}$ =47pF $L_{\sigma}$ , $C_{\sigma}$ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	164	-	
Fall time	$t_{f}$		-	43	-	
Turn-on energy	E <sub>on</sub>		-	61	-	μJ
Turn-off energy	E <sub>off</sub>		-	84	-	
Total switching energy	E <sub>ts</sub>		-	145	-	

# Switching Characteristic, Inductive Load, at $T_j$ =175 °C

Parameter	Symbol	Conditions	Value			I Incia
	Symbol		min.	Тур.	max.	Unit
IGBT Characteristic	·					
Turn-on delay time	$t_{d(on)}$	$T_j=175^{\circ}\text{C}$	-	14	-	ns
Rise time	t <sub>r</sub>	$V_{CC} = 400 \text{ V}, I_{C} = 4 \text{ A},$ $V_{GE} = 0/15 \text{ V},$	-	10	-	
Turn-off delay time	$t_{d(off)}$	$r_{\rm G}$ =47 $\Omega$ , $L_{\sigma}$ =150nH, $C_{\sigma}$ =47pF $L_{\sigma}$ , $C_{\sigma}$ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	185	-	
Fall time	$t_{f}$		-	83	-	
Turn-on energy	Eon		-	99	-	μJ
Turn-off energy	E <sub>off</sub>		-	97	-	
Total switching energy	E <sub>ts</sub>		-	196	-	

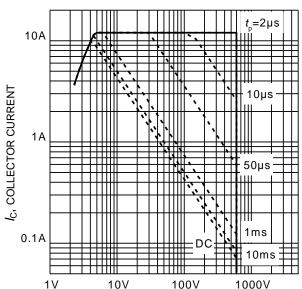






f, SWITCHING FREQUENCY

Figure 1. Collector current as a function of switching frequency  $(T_j \le 175^{\circ}\text{C}, D = 0.5, V_{\text{CE}} = 400\text{V}, V_{\text{GE}} = 0/15\text{V}, r_{\text{G}} = 47\Omega)$ 



 $V_{\text{CE}}$ , COLLECTOR-EMITTER VOLTAGE

Figure 2. Safe operating area  $(D=0, T_C=25^{\circ}\text{C}, T_j \leq 175^{\circ}\text{C}; V_{\text{GE}}=0/15\text{V})$ 

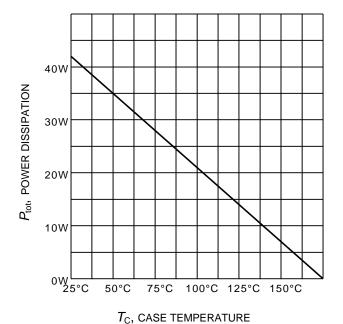


Figure 3. Power dissipation as a function of case temperature  $(T_i \le 175^{\circ}\text{C})$ 

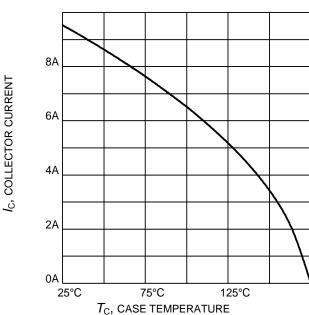


Figure 4. Collector current as a function of case temperature  $(V_{GE} \ge 15 \text{V}, \ T_j \le 175^{\circ}\text{C})$ 





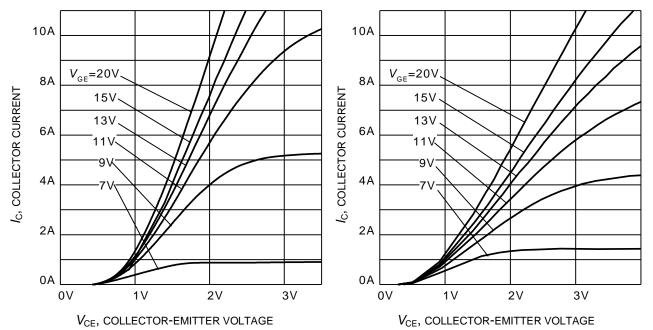


Figure 5. Typical output characteristic  $(T_i = 25^{\circ}C)$ 

Figure 6. Typical output characteristic  $(T_i = 175^{\circ}C)$ 

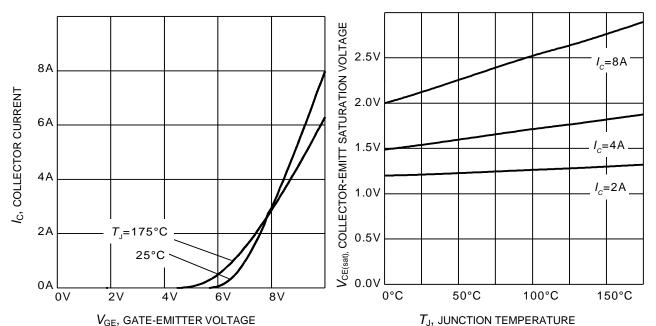
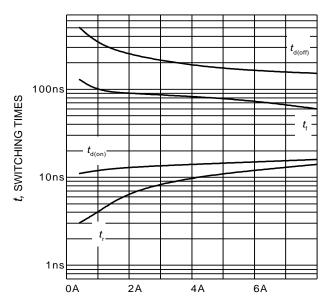


Figure 7. Typical transfer characteristic  $(V_{CE}=20V)$ 

Figure 8. Typical collector-emitter saturation voltage as a function of junction temperature  $(V_{GE} = 15V)$ 



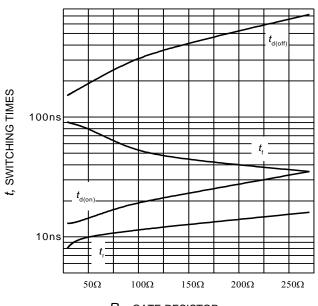




 $I_{\rm C}$ , COLLECTOR CURRENT

Figure 9. Typical switching times as a function of collector current

(inductive load,  $T_J$ =175°C,  $V_{CE}$  = 400V,  $V_{GE}$  = 0/15V,  $r_G$  = 47 $\Omega$ , Dynamic test circuit in Figure E)



 $R_{
m G}$ , gate resistor

Figure 10. Typical switching times as a function of gate resistor

(inductive load,  $T_J = 175^{\circ}\text{C}$ ,  $V_{CE} = 400\text{V}$ ,  $V_{GE} = 0/15\text{V}$ ,  $I_C = 4\text{A}$ , Dynamic test circuit in Figure E)

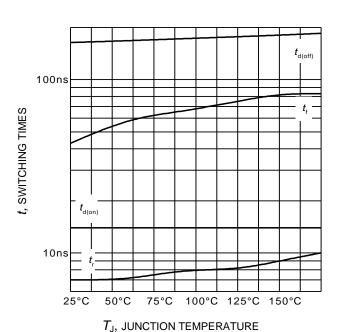
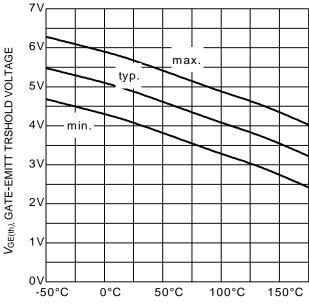


Figure 11. Typical switching times as a function of junction temperature

(inductive load,  $V_{\rm CE}$  = 400V,  $V_{\rm GE}$  = 0/15V,  $I_{\rm C}$  = 4A,  $r_{\rm G}$ =47 $\Omega$ , Dynamic test circuit in Figure E)



 $T_{\rm J}$ , JUNCTION TEMPERATURE

Figure 12. Gate-emitter threshold voltage as a function of junction temperature  $(I_C = 60 \mu A)$ 





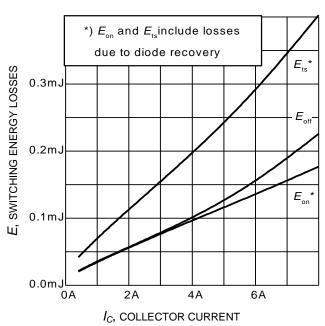


Figure 13. Typical switching energy losses as a function of collector current (inductive load,  $T_J$  = 175°C,  $V_{CE}$  = 400V,  $V_{GE}$  = 0/15V,  $r_G$  = 47 $\Omega$ , Dynamic test circuit in Figure E)

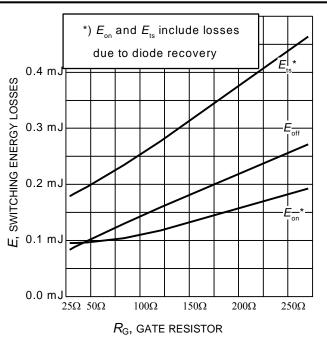


Figure 14. Typical switching energy losses as a function of gate resistor (inductive load,  $T_J = 175$ °C,  $V_{CE} = 400$ V,  $V_{GE} = 0/15$ V,  $I_C = 4$ A, Dynamic test circuit in Figure E)

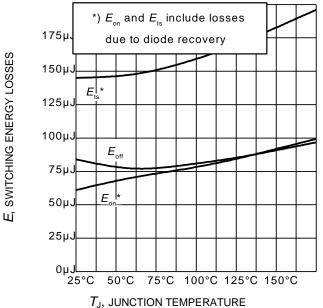
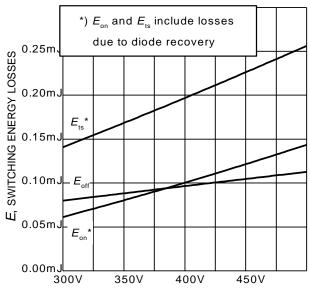


Figure 15. Typical switching energy losses as a function of junction temperature (inductive load,  $V_{\rm CE}$  = 400V,  $V_{\rm GE}$  = 0/15V,  $I_{\rm C}$  = 4A,  $I_{\rm CE}$  = 47 $\Omega$ , Dynamic test circuit in Figure E)



 $V_{CE}$ , COLLECTOR-EMITTER VOLTAGE

Figure 16. Typical switching energy losses as a function of collector emitter voltage

(inductive load,  $T_J$  = 175°C,  $V_{GE}$  = 0/15V,  $I_C$  = 4A,  $r_G$  = 47 $\Omega$ , Dynamic test circuit in Figure E)





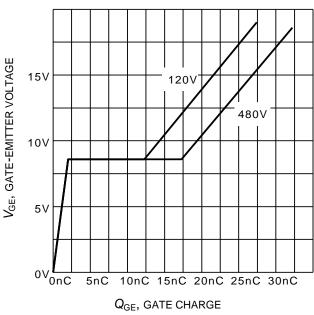
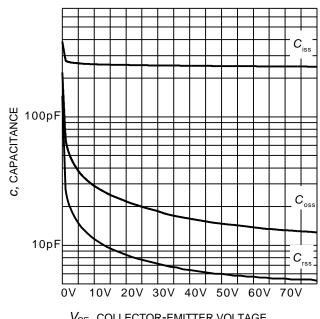


Figure 17. Typical gate charge  $(I_C=4 \text{ A})$ 



 $V_{\text{CE}}$ , COLLECTOR-EMITTER VOLTAGE

Figure 18. Typical capacitance as a function of collector-emitter voltage  $(V_{GE}=0V, f=1 \text{ MHz})$ 

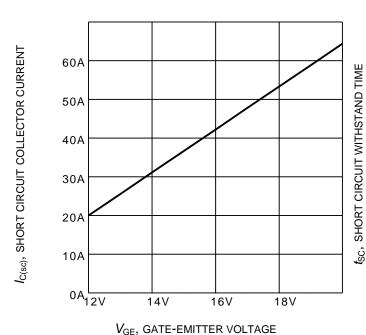
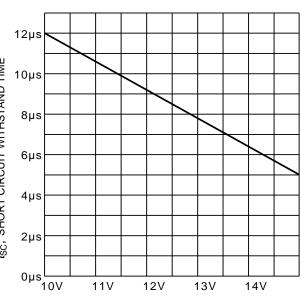
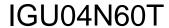


Figure 19. Typical short circuit collector current as a function of gate-emitter voltage  $(V_{CE} \le 400 \text{V}, \ T_i \le 150 ^{\circ}\text{C})$ 



 $V_{\rm GE}$ , gate-emitter voltage

Figure 20. Short circuit withstand time as a function of gate-emitter voltage ( $V_{\text{CE}}$ =400V, start at  $T_{\text{j}}$ =25°C,  $T_{\text{j,max}}$ <150°C)





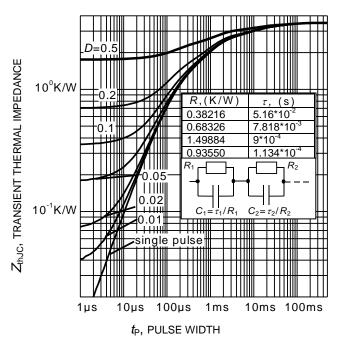


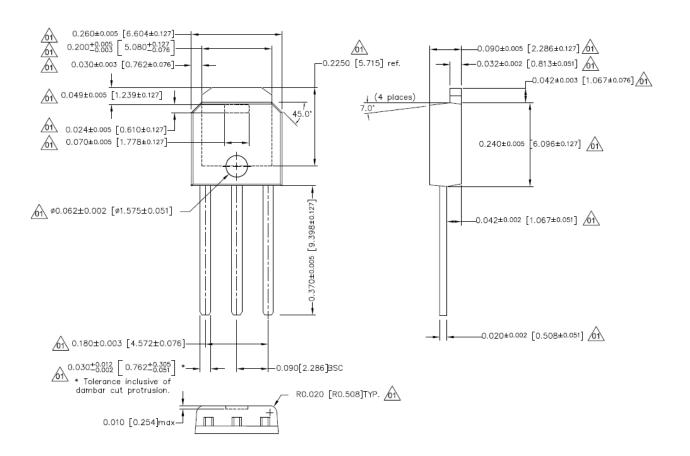
Figure 21. IGBT transient thermal impedance  $(D = t_p / T)$ 



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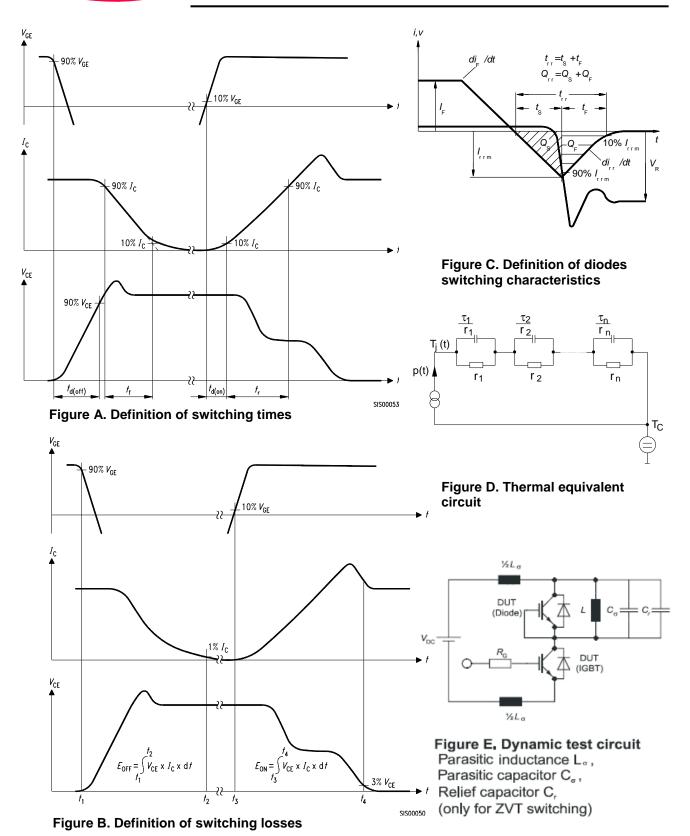
## TRENCHSTOP™ Series

## PG-TO251-3











# IGU04N60T

#### TRENCHSTOP™ Series

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